



WF25N, WF20N, WF12N, WF08N, WF06N ±1%, ±5% Thick Film High Voltage Chip Resistors UL Safety Certification

Size 2512,2010,1206, 0805, 0603



FEATURE

- 1. Special materials and design for higher working voltage required.
- 2. Compatible with flow and reflow soldering.
- 3. Suitable for lead free soldering.
- 4. Max. Voltage coefficient resistance below 300ppm.
- 5. RoHS compliant & Halogen Free.
- 6. Safety resistor certificate meet :
 - UL/IEC 60950-1 2.5 kV impulse.
 - UL/IEC 60065 10 kV impulse.

APPLICATION

- Power supply
- Measurement instrument
- Back light inverter
- Medical or Military equipment

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

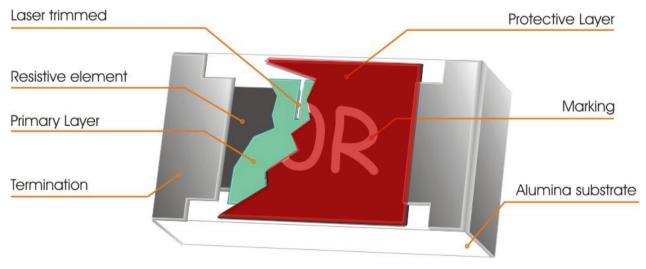


Fig 1. Construction of Chip-R

QUICK REFERENCE DATA

Туре	Size	Power Rating at 70°C	Max. RCWV	Max. Overload Voltage	Resistance Tolerance	Temperature Coefficient (ppm/°C)	Resistance Range Min. Max.		Standard Resistance Values
WF06N	0603	1/10W	200V	400V	±1%(F) ±5%(J)	±100 ±200	100KΩ 100KΩ	10MΩ 22MΩ	E96/E24 E24
WF08N	0805	1/8W	400V	800V	±1%(F) ±5%(J)	±100 ±200	100ΚΩ 100ΚΩ	10MΩ 22MΩ	E96/E24 E24
WF12N	1206	1/4W	800V	1600V	±1%(F) ±1%(F) ±5%(J)	±100 ±200 ±200	100ΚΩ 11ΜΩ 100ΚΩ	10MΩ 22MΩ 100MΩ	E96/E24 E24 E24
WF20N	2010	1/2W	2000∨	3000V	±1%(F) ±1%(F) ±5%(J)	±100 ±200 ±200	100ΚΩ 11ΜΩ 100ΚΩ	10MΩ 22MΩ 100MΩ	E96/E24 E24 E24
WF25N	2512	1W	3000∨	4000V	±1%(F) ±1%(F) ±5%(J)	±100 ±200 ±200	100ΚΩ 11ΜΩ 100ΚΩ	10ΜΩ 22ΜΩ 100ΜΩ	E96/E24 E24 E24

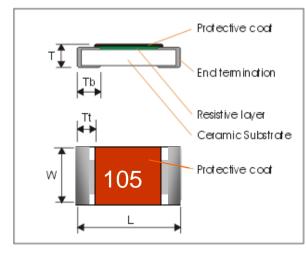
Note:

1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"

2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{RatedPower \times Resistance Value}$ or Max. RCWV listed above, whichever is lower.

MECHANICAL DATA



Symbol	WF25N	WF 20N	WF12N	WF08N	WF06N
L	6.40 ± 0.20	5.00 ± 0.20	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10
W	3.20 ±	2.50 ±	1.60 ±	1.25 ±	0.80 ±
	0.20	0.20	0.10	0.10	0.10
Т	0.60 ±	0.60 ±	0.55 ±	0.50 ±	0.45 ±
	0.15	0.10	0.10	0.10	0.10
Tt	0.65 ±	0.65 ±	0.50 ±	0.40 ±	0.30 ±
	0.25	0.25	0.20	0.20	0.20
Tb	0.90 ±	0.60 ±	0.50 ±	0.40 ±	0.30 ±
	0.25	0.25	0.20	0.20	0.20

MARKING

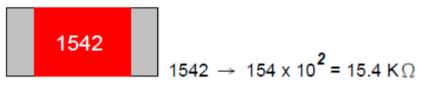
For E24 \pm 5% series, each resistor is marked with a three–digit code on the protective coating to designate the nominal resistance value.

0603/0805/1206/2010/2512



For E24/E96 \pm 1% series, each resistor is marked with a four-digit code on the protective coating to designate the nominal resistance value. 0603 is marked with three-digits.

0805/1206/2010/2512



E24 $\pm 1\%$: 3 Digits marking to identify the resistance value

0603

222
$$222 \rightarrow 22 \times 10^2 = 2.2 \text{ K}\Omega$$

E96 ±1% : 3 Digits marking to identify the resistance value

FUNCTIONAL DESCRIPTION

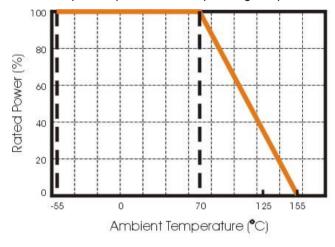
Product characterization

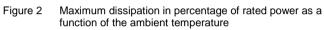
Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of \pm 1%, \pm 5%. The values of the E24/E96 series are in accordance with "IEC publication 60063".



Derating curve

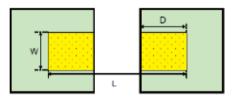
The power that the resistor can dissipate depends on the operating temperature; see Fig.2





Recommend Solder Pad Dimensions :

Туре	W	D	L
WF06N	0.90	1.00	3.00
WF08N	1.30	1.15	3.50
WF12N	1.80	1.30	4.70
WF20N	3.00	1.50	6.80
WF25N	3.70	1.60	7.60



Unit:mm



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

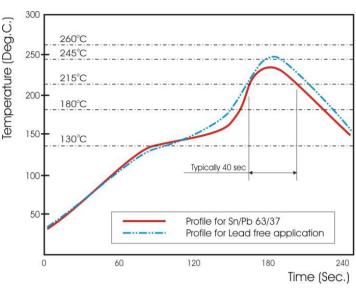


Fig 3. Infrared soldering profile

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WF25	N	N 105		т	L
Size code WF25 : 2512 WF20 : 2010 WF12 : 1206 WF08 : 0805	Type code N :High Voltage UL certified	Resistance code $\pm 5\%$ E24: 2 significant digits followed by no. of zeros and a blank 1 M Ω = 105 $\pm 1\%$, E24+E96: 3 significant	J Tolerance J : ±5% F : ±1%	Packaging code T : 7" inch reel 0603/0805/1206: paper tape, 5kpcs/reel 2010,2512 :	Termination code L = Sn base (lead free)
WF06 : 0603		digits followed by no. of zeros $1 \text{ M}\Omega = 1004$		plastic tape, 4kpcs/reel	

Tape packaging WF12, WF08, WF06 : 8mm width paper taping 5,000pcs per reel.

WF25 ; WF20: 12mm width plastic taping 4,000pcs per reel.

Storage &. Handling

... Products are recommended to be used up within one year as ensured shelf life.

Check solder ability in case shelf life extension is needed.

... To store products with following condition:

Temperature:5 to 40°C ; Humidity: 20 to 70% relative humidity.

TEST AND REQUIREMENTS(JIS C 5201-1: 1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range : Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

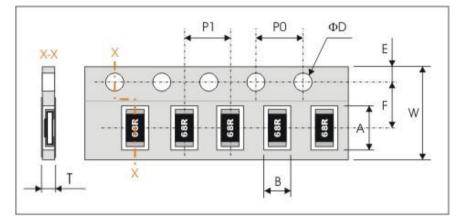
Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with midly activated flux.

TEST	PROCEDURE	REQUIREMENT		
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	Refer to "QUICK REFERENCE DATA"		
	R1: Resistance at reference temperature			
	R ₂ : Resistance at test temperature			
	t ₁ : 20°C+5°C-1°C			
Short time overload	Permanent resistance change after a 5 second application of	No visible damage		
(S.T.O.L)	5 times of rated power.	J: ∆R/R max. ±(2%+0.1Ω)		
Clause 4.13		F: ΔR/R max. ±(1%+0.1Ω)		
Resistance to soldering		no visible damage		
heat(R.S.H)	SAC solder bath at 260°C±5°C	∆R/R max. ±(1%+0.15Ω)		
Clause 4.18				
Solderability	Un-mounted chips completely immersed for 3±0.5second in a SAC solder bath at $245^{\circ}C \pm 5^{\circ}C$	good tinning (>95% covered)		
Clause 4.17		no visible damage		
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30	no visible damage		
Clause 4.19	minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	Δ R/R max. ±(1%+0.1 Ω)		
Load life (endurance)	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber	no visible damage		
Clause 4.25	controller $70\pm2^{\circ}$ C, 1.5 hours on and 0.5 hours off	J: ΔR/R max. ±(3%+0.1Ω)		
		F: Δ R/R max. \pm (1%+0.1 Ω)		
Load life in Humidity	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity	no visible damage		
Clause 4.24	chamber controller at $40^{\circ}C\pm 2^{\circ}C$ and 95% relative humidity, 1.5hours on and 0.5 hours off	J: ∆R/R max. ±(3%+0.1Ω)		
		F: ΔR/R max. ±(1%+0.1Ω)		
Bending strength	Resistors mounted on a 90mm glass epoxy resin PCB(FR4),	Δ R/R max. ±(0.5%+0.05 Ω)		
Clause 4.33	2512, 2010, 1206 bending : 2 mm once for 10 seconds			
	0805, 0603 bending: 3mm once for 10 seconds			
Insulation Resistance	Apply voltage 100+/-15V for 1minute	R≥1GΩ		
Clause 4.6				

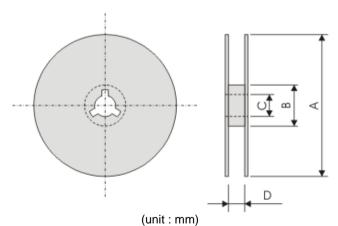
PACKAGING

Paper Tape specifications (unit :mm)



Series No.	А	B W		F	E	
WF25N	6.70±0.20	3.50±0.20	12.00±0.30	5.50±0.10	1.75±0.10	
WF20N	5.50±0.20	2.80±0.20	12.00±0.30	5.50±0.10	1.75±0.10	
WF12N	3.60±0.20	2.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10	
WF08N	2.40±0.20	1.65±0.20	1.65±0.20 8.00±0.30		1.75±0.10	
WF06N	1.90±0.20	1.10±0.20	8.00±0.30	3.50±0.20	1.75±0.10	
Series No.	P1	P0	ΦD	т		
WF25N				Max. 1.2		
WF20N			Ф1.50 ^{+0.1}	Wax. 1.2		
WF12N	4.00±0.10	4.00±0.10		Max. 1.0		
WF08N				IVIAX. 1.U		
WF06N				0.65±0.10		

Reel dimensions



А	B	С

Reel / Tape	А	В	С	D
7" reel for 12mm tape				12.4±1.0
	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	
7" reel for 8mm tape				9.0±0.5

Appendix

Code	E48	E96	Code	E48	E96	Code	E48	E96	Code	E48	E96
01	100	100	25	178	178	49	316	316	73	562	562
02		102	26		182	50		324	74		576
03	105	105	27	187	187	51	332	332	75	590	590
04		107	28		191	52		340	76		604
05	110	110	29	196	196	53	348	348	77	619	619
06		113	30		200	54		357	78		634
07	115	115	31	205	205	55	365	365	79	649	649
08		118	32		210	56		374	80		665
09	121	121	33	215	215	57	383	383	81	681	681
10		124	34		221	58		392	82		698
11	127	127	35	226	226	59	402	402	83	715	715
12		130	36		232	60		412	84		732
13	133	133	37	237	237	61	422	422	85	750	750
14		137	38		243	62		432	86		768
15	140	140	39	249	249	63	442	442	87	787	787
16		143	40		255	64		453	88		806
17	147	147	41	261	261	65	464	464	89	825	825
18		150	42		267	66		475	90		845
19	154	154	43	274	274	67	487	487	91	866	866
20		158	44		280	68		499	92		887
21	162	162	45	287	287	69	511	511	93	909	909
22		165	46		294	70		523	94		931
23	169	169	47	301	301	71	536	536	95	953	953
24		174	48		309	72		549	96		976
Code		A	в	ср	Е	F	G	н	х	Y	Z
Multipl			10 ¹ 10			_	10 6	10 7	10 -1	10 -2	10 -3

0603 1% Marking Table (Table 1)

※ All product specification and data are subject to change without notice.